

## Effect of Al<sub>2</sub>O<sub>3</sub> dopant on abnormal grain growth in BaTiO<sub>3</sub>

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### Abstract

The effect of additions of up to 1 mol% Al<sub>2</sub>O<sub>3</sub> on abnormal grain growth in BaTiO<sub>3</sub> has been studied. For samples sintered at temperatures ≤1250 °C addition of 0.1 mol% Al<sub>2</sub>O<sub>3</sub> increases the number density of abnormal grains, with further additions reducing the number density. For samples sintered at 1350 °C, addition of Al<sub>2</sub>O<sub>3</sub> caused the primary abnormal grain size to decrease and then increase. The results are explained by considering the effect of Al<sub>2</sub>O<sub>3</sub> addition on the TiO<sub>2</sub> content of grain boundaries.

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### 1. Introduction

BaTiO<sub>3</sub> is an important dielectric ceramic with many uses such as capacitors and positive temperature coefficient of resistance materials. In these applications, microstructure control is vital. Abnormal grain growth (AGG) should be avoided as it has a detrimental effect on mechanical and electrical properties.<sup>1</sup> AGG is affected by dopants, which form a liquid phase during sintering.<sup>2</sup>

When BaTiO<sub>3</sub> is donor-doped, its electrical behaviour changes from insulating to semiconducting, with a sharp increase in resistivity at the Curie point.<sup>3</sup> However, when the donor concentration exceeds 0.5 at.%, BaTiO<sub>3</sub> becomes insulating again and the grain size decreases dramatically. This is known as the grain growth anomaly<sup>4</sup> and has been studied extensively.<sup>4,5</sup> The effect of acceptor dopants on the grain growth of BaTiO<sub>3</sub> is less well known. Acceptor dopants are often present as impurities and are sometimes added as sintering aids.<sup>6–8</sup> Both Na<sub>2</sub>O and CaO inhibit abnormal grain growth.<sup>9,10</sup> In the present paper, the effect of Al<sub>2</sub>O<sub>3</sub> additions of up to 1 mol% on the abnormal grain growth behaviour of BaTiO<sub>3</sub> will be described.

### 2. Experimental

BaTiO<sub>3</sub> powders were prepared from Fuji Titanium HPBT-1 BaTiO<sub>3</sub> (99.8 wt.% purity, 0.66 μm size) and Sumitomo AKP-50 Al<sub>2</sub>O<sub>3</sub> (>99.99 wt.% purity, 0.1–0.3 μm size). The Ba/Ti ratio of the BaTiO<sub>3</sub> powder is 0.996, i.e. there is a slight TiO<sub>2</sub> excess. Powders were prepared with additions of 0, 0.1, 0.2, 0.5 and 1.0 mol% Al<sub>2</sub>O<sub>3</sub>. The powders were ball milled in ethanol in polypropylene jars using ZrO<sub>2</sub> milling media. After milling, the slurries were dried, crushed and passed through a 150-μm sieve. Samples 9 mm in diameter and 4 mm thick were prepared by cold isostatic pressing at 200 MPa. Samples were placed on BaTiO<sub>3</sub> spacers in an alumina crucible and sintered in an alumina tube furnace. Samples were sintered at 1200, 1250, 1300 and 1350 °C. The sintering time for the samples sintered at 1200 and 1250 °C was 100 h. The sintering time for the samples sintered at 1300 and 1350 °C was 1 h.

Samples for optical microscopy and scanning electron microscopy were sectioned, polished to a 0.25-μm finish and etched in a 1% HF–4% HCl solution for ~5 s. Abnormal grain number density was measured from optical micrographs. The 2D primary abnormal grain size was measured using an image analyzing program (Matrox Inspector) and divided by 0.76 to determine the 3D grain size.<sup>11</sup> Samples for SEM were gold

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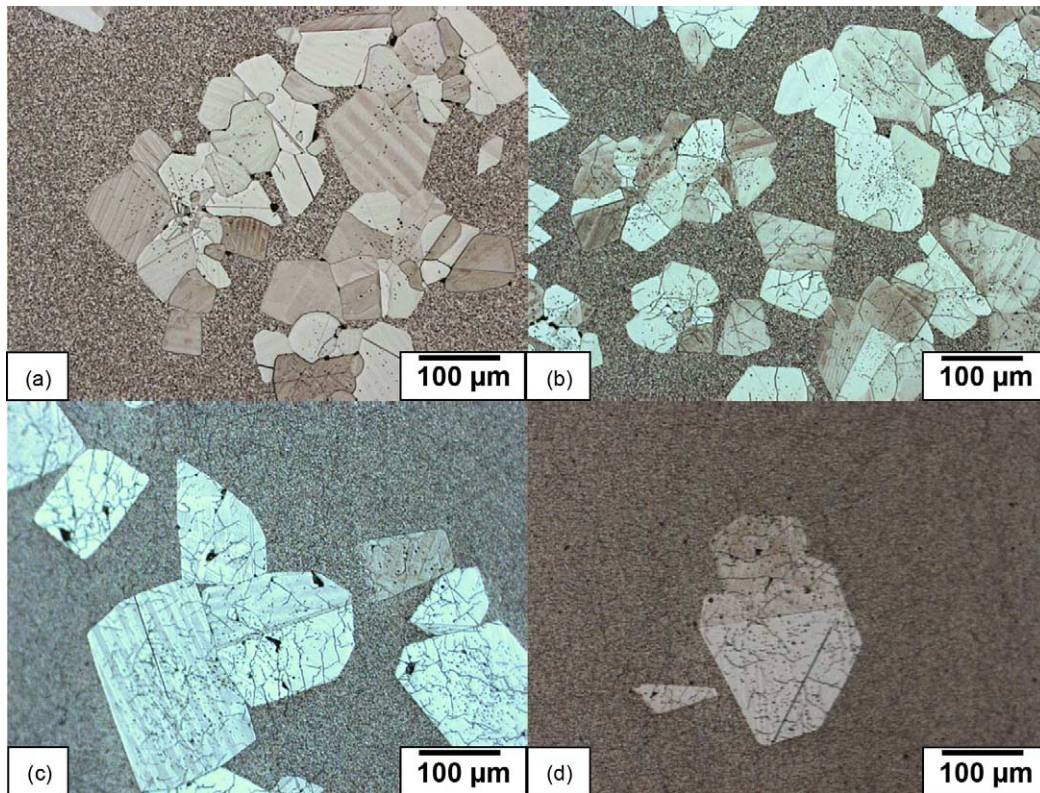


Fig. 1. BaTiO<sub>3</sub> samples doped with: (a) 0; (b) 0.1; (c) 0.5 and (d) 1.0 mol% Al<sub>2</sub>O<sub>3</sub> sintered at 1250 °C for 100 h.

coated and viewed in a Model XL 30 S FEG SEM (Philips, Eindhoven, Netherlands). Samples were also prepared for wavelength dispersive spectroscopy (WDS). Samples were polished and etched as above, carbon coated, and viewed in a Model 515 SEM (Philips, Eindhoven, Netherlands).

### 3. Results

Optical micrographs of samples sintered at 1250 °C for 100 h are shown in Fig. 1. The microstructures are bimodal, with fine matrix grains and faceted abnormal grains. Addition of 0.1 mol% Al<sub>2</sub>O<sub>3</sub> causes an increase in the number of abnormal grains, with further additions causing a decrease. At an addition of 1 mol% Al<sub>2</sub>O<sub>3</sub>, abnormal grain growth is almost entirely absent.

Optical micrographs of samples sintered at 1350 °C for 1 h are shown in Fig. 2. In all the samples primary abnormal grain growth (PAGG) has taken place, the fine matrix grains having been completely consumed by coarse primary abnormal grains (PAG). Addition of Al<sub>2</sub>O<sub>3</sub> up to 0.5 mol% causes a reduction in PAG size. Further addition of Al<sub>2</sub>O<sub>3</sub> causes an increase in PAG size.

The effect of Al<sub>2</sub>O<sub>3</sub> addition on the number density of abnormal grains is shown in Fig. 3. For samples sintered at 1200 and 1250 °C, addition of 0.1 mol% Al<sub>2</sub>O<sub>3</sub> causes a large increase in the number density of abnormal grains. Further additions cause a sharp decrease in the number density of abnormal grains. At additions of 1 mol% Al<sub>2</sub>O<sub>3</sub>, abnormal grain growth has almost ceased.

For samples sintered at 1300 and 1350 °C, abnormal grain number density increases with Al<sub>2</sub>O<sub>3</sub> content and then de-

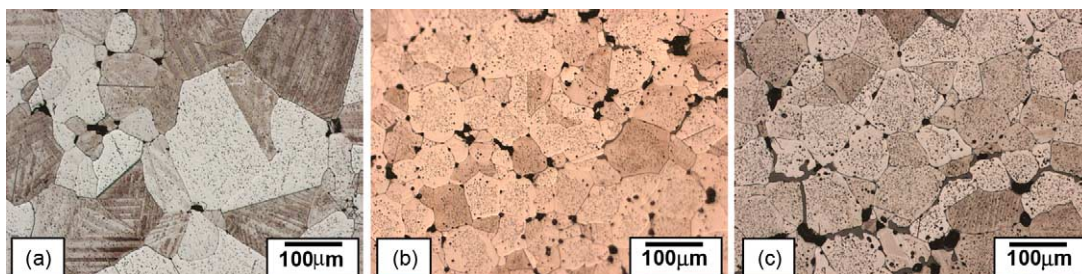


Fig. 2. BaTiO<sub>3</sub> samples doped with: (a) 0; (b) 0.5 and (c) 1.0 mol% Al<sub>2</sub>O<sub>3</sub> sintered at 1350 °C for 1 h.



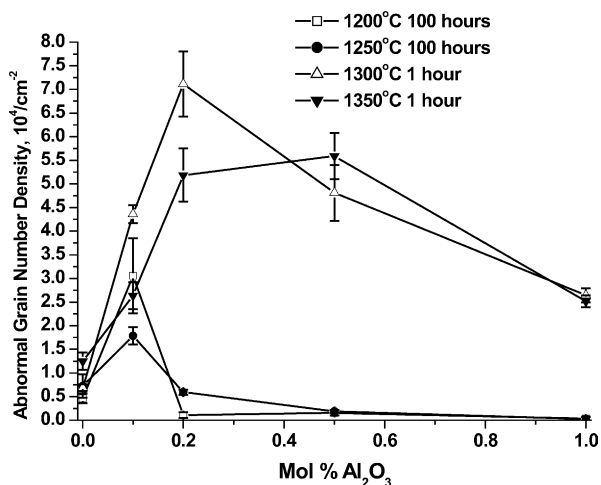


Fig. 3. Effect of Al<sub>2</sub>O<sub>3</sub> addition on abnormal grain number density.

creases gradually. As the sintering temperature increases, the point at which abnormal grain number density reaches its maximum value shifts to higher Al<sub>2</sub>O<sub>3</sub> contents (0.2 mol% Al<sub>2</sub>O<sub>3</sub> for samples sintered at 1300 °C, 0.5 mol% Al<sub>2</sub>O<sub>3</sub> for samples sintered at 1350 °C). In the samples sintered at 1300 °C, although the number density of abnormal grains decreases with addition of more than 0.2 mol% Al<sub>2</sub>O<sub>3</sub>, the size of the abnormal grains continues to increase. The samples containing 0.5 and 1.0 mol% Al<sub>2</sub>O<sub>3</sub> show almost complete PAGG. It should be noted that, technically speaking, the samples sintered at 1350 °C display normal grain growth, as the original fine grained matrix has been completely consumed by PAGG to form a normal distribution of coarse grains. However, for the sake of comparison, in this paper they shall be considered to be abnormal grains.

SEM micrographs of samples containing 0.5 mol% Al<sub>2</sub>O<sub>3</sub> sintered at 1200 °C for 100 h and 1350 °C for 1 h are shown in Fig. 4. The sample sintered at 1200 °C contains precipitates both in the abnormal grains and in the matrix. WDS of these precipitates gives them the composition Ba<sub>4</sub>Al<sub>2</sub>Ti<sub>10</sub>O<sub>27</sub>. This precipitate is present in the samples with more than 0.1 mol% of Al<sub>2</sub>O<sub>3</sub> sintered at 1200 and 1250 °C. The sample sintered at

1350 °C for 1 h has faceted solid/liquid interfaces between the primary abnormal grains. As Al<sub>2</sub>O<sub>3</sub> is added, an amorphous phase builds up at the solid/liquid interfaces and at triple junctions (marked with arrows). In the sample with 1 mol% Al<sub>2</sub>O<sub>3</sub> this phase has almost completely penetrated the solid/liquid interfaces. All of the samples show faceted grain boundaries or solid/liquid interfaces, regardless of Al<sub>2</sub>O<sub>3</sub> content or sintering temperature.

#### 4. Discussion

The samples can be separated into two groups: samples sintered at temperatures ≤1250 °C and samples sintered at temperatures ≥1300 °C. In the samples sintered at temperatures ≤1250 °C, Al<sub>2</sub>O<sub>3</sub> is incorporated into the BaTiO<sub>3</sub> lattice by substitution for TiO<sub>2</sub>. TiO<sub>2</sub> leaves the BaTiO<sub>3</sub> lattice and segregates at the grain boundaries. Excess TiO<sub>2</sub> is known to promote abnormal grain growth in BaTiO<sub>3</sub> temperatures ≤1250 °C.<sup>12,13</sup> In the sample with 0.1 mol% Al<sub>2</sub>O<sub>3</sub>, the Al<sub>2</sub>O<sub>3</sub> is completely incorporated into the BaTiO<sub>3</sub> lattice. This causes segregation of TiO<sub>2</sub> at the grain boundaries and promotes abnormal grain growth. In samples with more than 0.1 mol% Al<sub>2</sub>O<sub>3</sub>, Ba<sub>4</sub>Al<sub>2</sub>Ti<sub>10</sub>O<sub>27</sub> precipitate formation removes TiO<sub>2</sub> from the grain boundaries, leading to a decrease in the number of abnormal grains. Similar behaviour occurs in BaTiO<sub>3</sub> doped with Na<sub>2</sub>O.<sup>9</sup> Abnormal grain growth could also be caused by inhomogeneities in the green compact microstructure such as agglomerate formation. However, such inhomogeneities should lead to a random abnormal grain growth behaviour with varying Al<sub>2</sub>O<sub>3</sub> content, whereas our samples showed a definite pattern.

In the samples sintered at temperatures ≥1300 °C, Al<sub>2</sub>O<sub>3</sub> dissolves in the BaTiO<sub>3</sub> lattice as above, releasing TiO<sub>2</sub>. The excess TiO<sub>2</sub> reacts with un-dissolved Al<sub>2</sub>O<sub>3</sub> and impurities to create a liquid film between the grains. The eutectic point in the BaTiO<sub>3</sub> system can be lowered to ~1250 °C by the addition of Al<sub>2</sub>O<sub>3</sub>–SiO<sub>2</sub>–TiO<sub>2</sub>.<sup>14</sup> This liquid film can promote primary abnormal grain growth at temperatures lower than 1332 °C.<sup>15</sup> As the amount of Al<sub>2</sub>O<sub>3</sub> increases, the volume

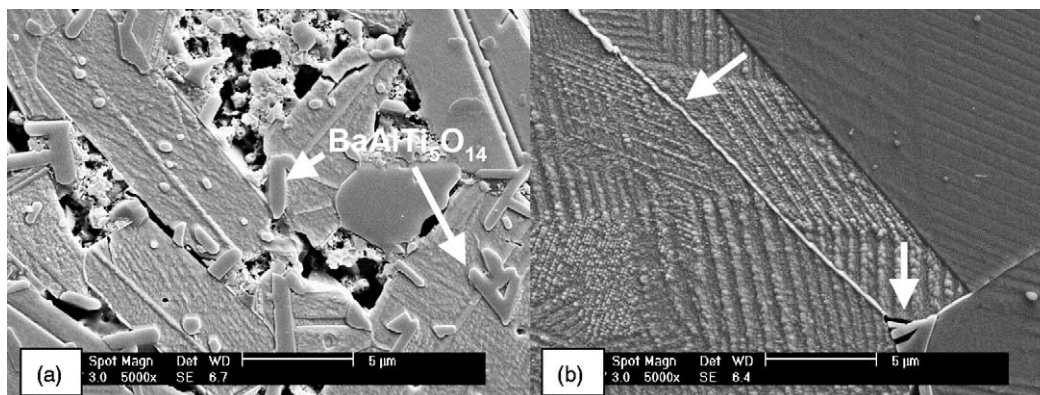


Fig. 4. (a) 0.5 mol% Al<sub>2</sub>O<sub>3</sub>, 1200 °C, 100 h; (b) 0.5 mol% Al<sub>2</sub>O<sub>3</sub>, 1350 °C, 1 h.

of liquid film at the interfaces increases. This liquid film is expected to reduce the growth rate of the primary abnormal grains, leading to a reduction in PAG size. Such behaviour has been noted in Ca-doped BaTiO<sub>3</sub>.<sup>10</sup> In the Al<sub>2</sub>O<sub>3</sub>-doped samples, addition of up to 0.5 mol% Al<sub>2</sub>O<sub>3</sub> causes a reduction in PAG size, but further addition of Al<sub>2</sub>O<sub>3</sub> causes an increase. The reason for this is not yet clear but may be due to secondary abnormal grain growth. Addition of SiO<sub>2</sub> to BaTiO<sub>3</sub> is known to induce secondary abnormal grain growth.<sup>16</sup> Further, sintering experiments are being carried out to see if this is the case.

## 5. Conclusions

BaTiO<sub>3</sub> has been doped with up to 1 mol% Al<sub>2</sub>O<sub>3</sub> and sintered at various temperatures. For samples sintered at temperatures  $\leq 1250$  °C, addition of up to 0.1 mol% Al<sub>2</sub>O<sub>3</sub> promotes abnormal grain growth, with further additions of Al<sub>2</sub>O<sub>3</sub> inhibiting it. AGG promotion is caused by Al<sub>2</sub>O<sub>3</sub> dissolving in the BaTiO<sub>3</sub> lattice and releasing TiO<sub>2</sub>. AGG inhibition occurs by Al<sub>2</sub>O<sub>3</sub> reacting with excess TiO<sub>2</sub> and BaTiO<sub>3</sub> to form Ba<sub>4</sub>Al<sub>2</sub>Ti<sub>10</sub>O<sub>27</sub>. For samples sintered at temperatures  $\geq 1250$  °C, Al<sub>2</sub>O<sub>3</sub> reacts with excess TiO<sub>2</sub> and impurities to form a thick liquid film at the grain boundaries. As the Al<sub>2</sub>O<sub>3</sub> content increases, the volume of the liquid film increases, retarding grain growth. However addition of 1 mol% Al<sub>2</sub>O<sub>3</sub> causes grain growth to increase. This may be due to secondary abnormal grain growth.

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